

IPB020N04N G-VB Datasheet N-Channel 40 V (D-S) 175 °C MOSFET

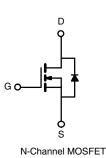
PRODUCT SUMMARY				
V _{DS} (V)	40			
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.0015			
I _D (A)	200			
Configuration	Single			
Package	TO-263-7L			

FEATURES

- Trench power MOSFET
- Package with low thermal resistance
- 100 % Rg and UIS tested







ABSOLUTE MAXIMUM RATING	GS (T _C = 25 °C, unless	otherwise noted	l)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	40		
Gate-Source Voltage		V _{GS}	± 20	V	
Continuous Drain Current	$T_{C} = 25 \ ^{\circ}C \ ^{a}$	1	200	A	
	T _C = 125 °C	I _D	192		
Continuous Source Current (Diode Conduc	tion) ^a	I _S	200		
Pulsed Drain Current ^b	I _{DM}	600			
Single Pulse Avalanche Current		I _{AS}	85		
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	361	mJ	
Maximum Power Dissipation ^b	T _C = 25 °C	- P _D	375	w	
	T _C = 125 °C		125		
Operating Junction and Storage Temperature Range		T _J , T _{sta}	-55 to +175	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-Ambient	PCB Mount ^c	R _{thJA}	40	°C/W	
Junction-to-Case (Drain)		R _{thJC}	0.4	0/10	

Notes

a. Package limited.

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

c. When mounted on 1" square PCB (FR4 material).

d. Parametric verification ongoing.

PARAMETER	SYMBOL	TEO						
Statio		vise noted) TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static		•						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$		40	-	-	v	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		2.5	3.0	3.5	v	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	-	± 100	nA	
		$V_{GS} = 0 V$	$V_{DS} = 40 V$	-	-	1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V$	$V_{DS} = 40 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	-	50	μA	
		$V_{GS} = 0 V$	$V_{DS} = 40 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$	-	-	250		
On-State Drain Current ^a	I _{D(on)}	$V_{GS} = 10 V$	$V_{DS} \ge 5 V$	200	-	-	А	
		$V_{GS} = 10 V$	I _D = 30 A	-	0.0015	-	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 10 V$	$I_D = 30 \text{ A}, \text{T}_\text{J} = 125 \ ^\circ\text{C}$	-	0.0028	-		
		$V_{GS} = 10 V$	$I_D = 30 \text{ A}, \text{T}_\text{J} = 175 \ ^\circ\text{C}$	-	0.0034	-		
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 30 A		-	198	-	S	
Dynamic ^b								
Input Capacitance	C _{iss}			-	13 880	17 350		
Output Capacitance	C _{oss}	$V_{GS} = 0 V$	V _{GS} = 0 V V _{DS} = 25 V, f = 1 MHz		1414	1770	pF	
Reverse Transfer Capacitance	C _{rss}			-	840	1050		
Total Gate Charge ^c	Qg			-	206	310		
Gate-Source Charge ^c	Q _{gs}	$V_{GS} = 10 V$	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 120 \text{ A}$	-	50	-	nC	
Gate-Drain Charge ^c	Q _{gd}			-	44	-		
Gate Resistance	R _g	f = 1 MHz		0.25	0.8	1.8	Ω	
Turn-On Delay Time ^c	t _{d(on)}	$V_{DD} = 20 \text{ V}, \text{ R}_{\text{L}} = 0.17 \Omega$ $\text{I}_{\text{D}} \cong 120 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		-	26	39		
Rise Time ^c	tr			-	21	32	- ns	
Turn-Off Delay Time ^c	t _{d(off)}			-	68	102		
Fall Time ^c	t _f			-	12	18		
Source-Drain Diode Ratings and Char	acteristics ^b			•	•	-		
Pulsed Current ^a	I _{SM}			-	-	600	А	
Forward Voltage	V _{SD}	I _F = 80 A, V _{GS} = 0 V		-	0.86	1.5	V	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

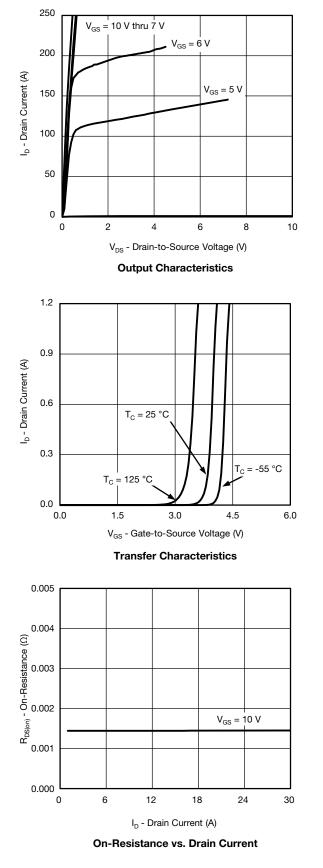
c. Independent of operating temperature.

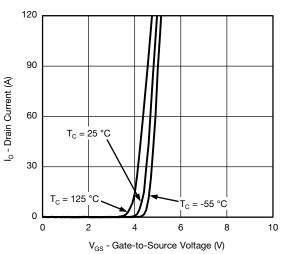
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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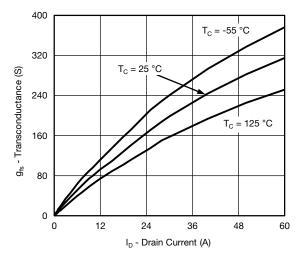


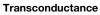
TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)

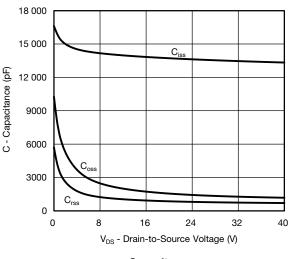




Transfer Characteristics



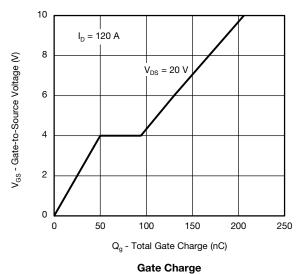


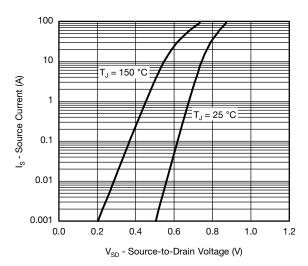


Capacitance

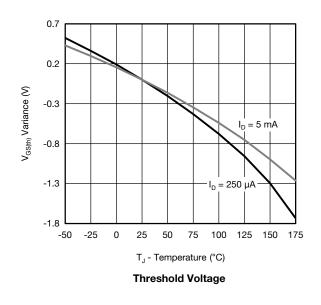


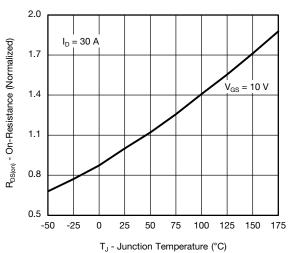
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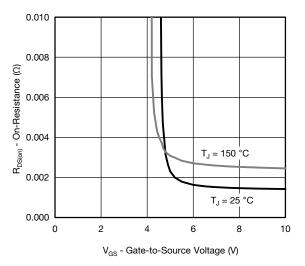


Source Drain Diode Forward Voltage

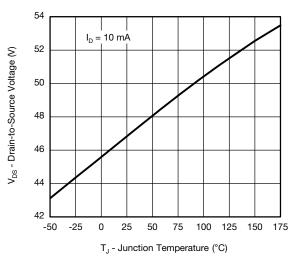




On-Resistance vs. Junction Temperature



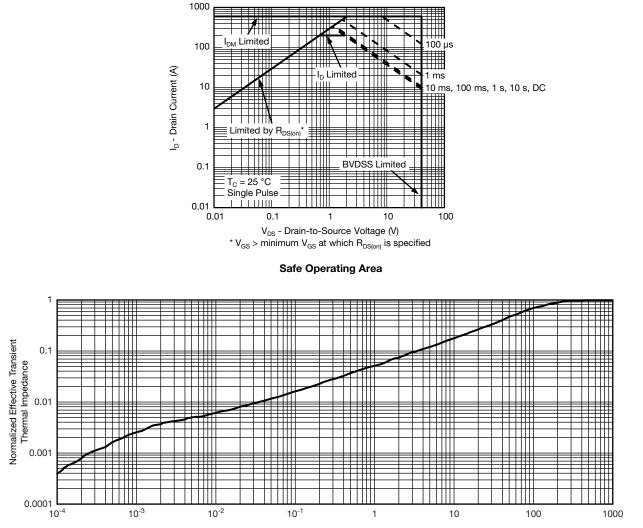




Drain Source Breakdown vs. Junction Temperature



THERMAL RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)

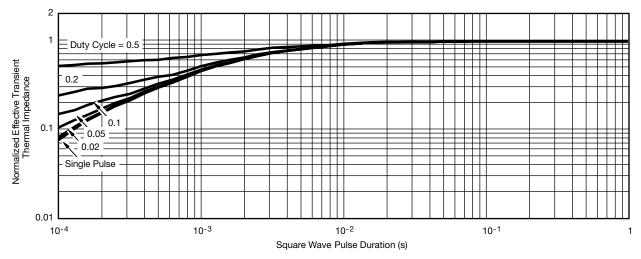


Square Wave Pulse Duration (s)

Normalized Thermal Transient Impedance, Junction-to-Ambient



THERMAL RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

• The characteristics shown in the two graphs

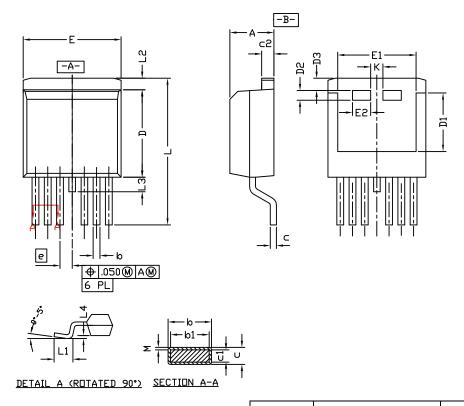
- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.



D²PAK (TO-263-7L) Case Outline



Notes

- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- 3. Pin to pin coplanarity max. 4 mils.
- 4. Lead thickness 25 mils.
- 5. For SUM part numbers lead thickness is 24 mils to 29 mils.
- 6. For reference only.
- 7. Use inches as the primary measurement.
- 8. This feature is only for SUM.

	INCHES		MILLIMETERS	
DIM.	MIN.	MAX.	MIN.	MAX.
Α	0.160	0.190	4.064	4.826
b	0.020	0.039	0.508	0.990
b1	0.020	0.035	0.508	0.889
b2	0.045	0.055	1.143	1.397
c* SUB	0.012	0.018	0.305	0.457
c* SUM	0.022	0.028	0.559	0.711
c1	0.018	0.025	0.457	0.635
c2	0.045	0.055	1.143	1.397
D	0.340	0.380	8.636	9.652
D1	0.220	0.240	5.588	6.096
D2	0.038	0.042	0.965	1.067
D3	0.045	0.055	1.143	1.397
E	0.380	0.410	9.652	10.414
E1	0.245	-	6.223	-
E2	0.072	0.078	1.829	1.981
е	0.050 BSC		1.27 BSC	
К	0.045	0.055	1.143	1.397
L	0.575	0.625	14.605	15.875
L1	0.090	0.110	2.286	2.794
L2	0.040	0.055	1.016	1.397
L3	0.050	0.070	1.270	1.778
L4	0.010 BSC		0.254 BSC	
М	-	0.002	-	0.050
ECN: T13-0709-Rev. B, 30-Sep-13 DWG: 6006				



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